

Atty Docket No. JCLA6643-R2

Serial No. 09/801,350

In The Claims:

Please amend the claims as follows:

1. (currently amended) An electrostatic discharge (ESD) protection circuit, suitable for use on the I/O pad, the ESD protection circuit comprising:

a silicon controlled rectifier (SCR) circuit, which comprises a first connection terminal, a second connection terminal, and a third connection terminal, wherein the first connection terminal and the second connection terminal are respectively connected to the I/O pad and a ground voltage, so as to discharge the electrostatic charges; and

an anti-latch-up circuit, which comprises a fourth connection terminal, a fifth connection terminal, and a sixth connection terminal, respectively coupled to a voltage source, the ground voltage, and the third connection terminal of the SCR circuit, wherein the sixth connection terminal of the anti-latch-up circuit is directly connected to the third connection terminal of the SCR circuit, whereby an anti-latch-up signal is sent from the sixth connection terminal to the SCR circuit for preventing latching up of the SCR circuit during normal operation, wherein SCR circuit is triggered by an ESD event, and wherein the I/O pad is not directly connected to the voltage source and the anti-latch-up circuit.

2. (original) The ESD protection circuit of claim 1, further comprising:

a first diode, having a first input end and a second input end, respectively connected to the ground voltage and the I/O pad; and

a second diode, having a first input end and a second input end, respectively connected to the I/O pad and a voltage source.

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3. (previously presented) The ESD protection circuit of claim 1, wherein the SCR circuit comprises:

a P-type substrate;

an N well, formed in the p-type substrate;

a first P+ doped region, formed in the P-type substrate and coupled to the ground voltage;

a first N+ doped region, formed in the P-type substrate, adjacent to the first P+ doped region, and coupled to the ground voltage;

a second N+ doped region, formed between the P-type substrate and the N well, adjacent to the first N+ doped region, coupled via the third connection terminal of SCR circuit to the sixth connection terminal of the anti-latch-up circuit, serving as a guard ring to collect electrons to avoid latch up when the anti-latch-up circuit sends the anti-latch-up signal through the sixth connection terminal to the third connection terminal of the SCR circuit during normal operation, and floating when the anti-latch-up circuit sends no signal to the SCR circuit during an ESD event;

a second P+ doped region, formed in the N well, adjacent to the second N+ doped region, and coupled to the I/O pad; and

a third N+ doped region, formed in the N well, adjacent to the second P+ doped region, and coupled to the voltage source;

wherein a diode is coupled to the second P+ doped region and the I/O pad at one end and coupled to the voltage source at the other end.

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4. (original) The ESD protection circuit of claim 3, wherein the anti-latch-up circuit comprises:

a capacitor, having a first contact end and a second contact end, respectively coupled to the second N+ doped region and the ground voltage; and

a resistor, having a first end and a second end, respectively coupled to the voltage source and the second N+ doped region.

Claims 5-12. (canceled)

13. (previously presented) The ESD protection circuit of claim 1, wherein the anti-latch-up signal sent from the sixth connection terminal to the SCR circuit comprises a voltage signal.

Claim 14. (canceled)